## Fast-Acting Brick SMD Fuse Multicomp PRO





## RoHS **Compliant**

#### **Description**

The SMD fuse for the small size and good electrical performance reliability and quality the solder-free design provides excellent on-off and temperature cycling characteristics during use and also makes our SMD fuses more heat and shock tolerant than typical brick fuses.

#### **Features**

- Rapid interruption of excessive current
- Ceramic body and silver plated copper terminal
- Excellent environmental integrity
- One time positive disconnect
- Lead-free and Halogen-free
- Designed to UL 248-14

#### **Specifications**

**Operating Temperature** : -55°C to +125°C Storage Conditions : +10°C to +60°C

Relative Humidity : ≤ 75% yearly average without dew, maximum 30 days at 95%

Vibration Resistance : 24 cycles at 15 min. each

> 10-60Hz at 0.75mm amplitude 60-2000Hz at 10g acceleration

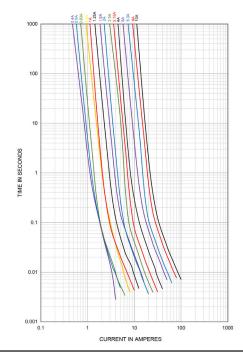
#### **Electrical Characteristics**

**Time vs Current Characteristics Table** 

(measured with constant current power supply)

Time vs Current Characteristics		
Rated current	100%	200%
0.4A to 10A	>4h	<60s

## Average Time Current (I-T) Curves



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#### Electrical Characteristics at 25°C

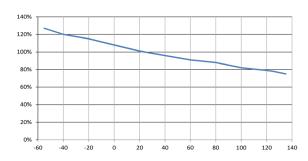
Amp Code	Rated Current	Rated Voltage DC	Max. Voltage Drop (mV)	Breaking Capacity	Typical Melting I <sup>2</sup> T (A <sup>2</sup> s)	Typ. Cold Resistance (mΩ)
1100	1A	125V AC	300	150A@125V AC	0.47	103 to 191
1200	2A	250V AC 125V DC 250V DC 400V DC	150	150A@250V AC 150A@125V DC 150A@250V DC 100A@400V DC	1.84	36.7 to 68.1

#### Note:

- (1) Permissible continuous operating current is ≤100% at ambient temperature of 23°C (73.4°F)
- (2) The current values used for calculating I<sup>2</sup>T should be within the standard range of 8ms~10ms.

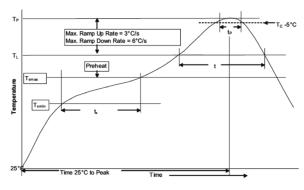
### Temperature Re-rating Curve

#### **Temperature Derating Curve**



Operating Current (A) Calculation for ideal fuse selection = Rating (% 0.75)

## **Soldering Parameters**



1. Infrared Reflow:

Temperature: 260°C Time: 30sec Max.

Recommend reflow profile

2. Wave Soldering:

Reservoir Temperature: 260°C Time in Reservoir: 10sec Max.

Profile Feature		Pb-Free Assembly	
Average Ramp-UP Rate(Tsmax to Tp)		3°C/s Max.	
Preheat	Temperature Min (Ts min)	150°C	
	Temperature Max (Ts max)	200°C	
	Time (Tsmin to Ts max)	60sec to 120sec	
Liquidous temperature(TL) Time at liquidous(tL)		217°C 60 to 150S	
Peak package body temperature (Tp)		260°C	
Time (tP) within 5°C of the specified classification temperature (Tc)		30S	
Average ramp-down rate (Tp to Tsmax)		6°C/s Max.	
Time (25°C to Peak Temperature)		8 Minutes Max.	

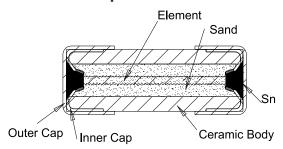
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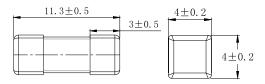
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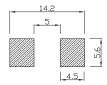
### **Mechanical Specifications**



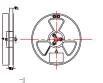
#### **Diagram**



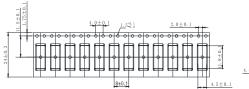
#### **Recommended Land Pattern**



### **Packing Information**



Α	N (Min.)	<b>W</b> 1	W2 (Max.)	С
330	100	24.4 +2	30.4	13 ±0.25





#### **Part Number Table**

Description	Part Number
Brick SMD Fuse, Fast-Acting, 1A, 250V AC / 400V DC	MP001615
Brick SMD Fuse, Fast-Acting, 1A, 250V AC / 400V DC	MP006276
Brick SMD Fuse, Fast-Acting , 2A, 250V AC / 400V DC	MP006277

**Dimensions: Millimetres** 

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